SEMICONDUCTOR

2N65
650V N-Channel Power MOSFET

FEATURES

- $R_{DS(ON)}$<4.4Ω @ V_{GS}=10V,ID=1A
- Fast switching capability
- Lead free in compliance with EU RoHS directive.
- Improved dv/dt capability,high ruggedness

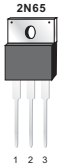
MECHANICAL DATA

- Case:TO-220,ITO-220,TO-251,TO-252, TO-262, TO-263 Package

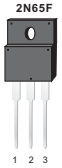
PRODUCT SUMMARY

V_{DS} (V)	$R_{DS(on)}$(Ω)	I_D (A)
650	4.4 @ V_{GS}=10V	2

TO-220AB 2N65

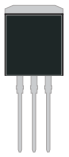


ITO-220AB 2N65F



TO-263 2N65D

TO-262 2N65E



TO-251 2N65N

TO-252 2N65M

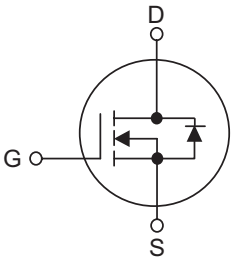
Ordering Information

Part No.	Package	Packing
2N65-TU	TO-220	50pcs / Tube
2N65F-TU	ITO-220	50pcs / Tube
2N65E-TU	TO-262	50pcs / Tube
2N65D-TU	TO-263	50pcs / Tube
2N65D-TR	TO-263	800pcs / 13"Reel
2N65N-TU	TO-251	75pcs / Tube
2N65M-TU	TO-252	75pcs / Tube
2N65M-TR	TO-252	2.5Kpcs / 13"Reel

Pin Definition:

1. Gate
2. Drain
3. Source

Block Diagram



ABSOLUTE MAXIMUM RATINGS (T_C=25 C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	650	V
Gate-Source Voltage		V_{GSS}	3 0	V
Continuous Drain Current		I_D	2.0	A
Pulsed Drain Current (Note 2)		I_{DM}	8.0	A
Avalanche Energy		E_{AS}	115	mJ
Power Dissipation	TO-220/TO-263/TO-262	P_D	44	W
	ITO-220		23	
	TO-251/TO-252		34	
Junction Temperature		T_J	+150	C
Storage Temperature		T_{STG}	-55 ~ +150	C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3. L=30mH, I_{AS}=2.7A,V_{DD}=50V,R_G=25Ω,Starting T_J=25 C

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650V N-Channel Power MOSFET

THERMAL DATA

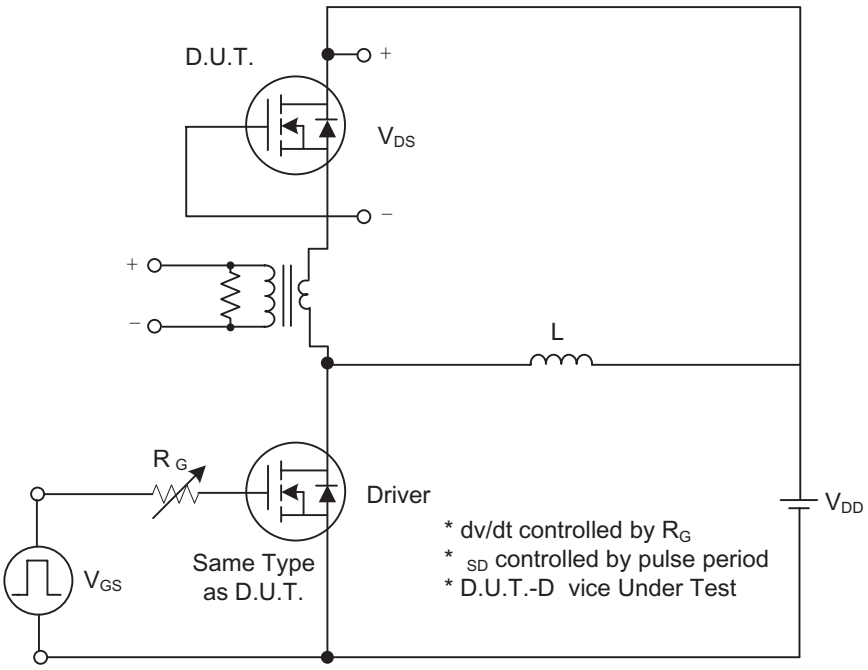
PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/ITO-220 TO-262/TO-263	θ_{JA}	62.5	C/W
	TO-251/TO-252		110	
Junction to Case	TO-220/TO-263/TO-262	θ_{JC}	2.35	C/W
	ITO-220		5.5	
	TO-251/TO-252		2.9	

ELECTRICAL CHARACTERISTICS (T_C=25 C, unless otherwise specified)

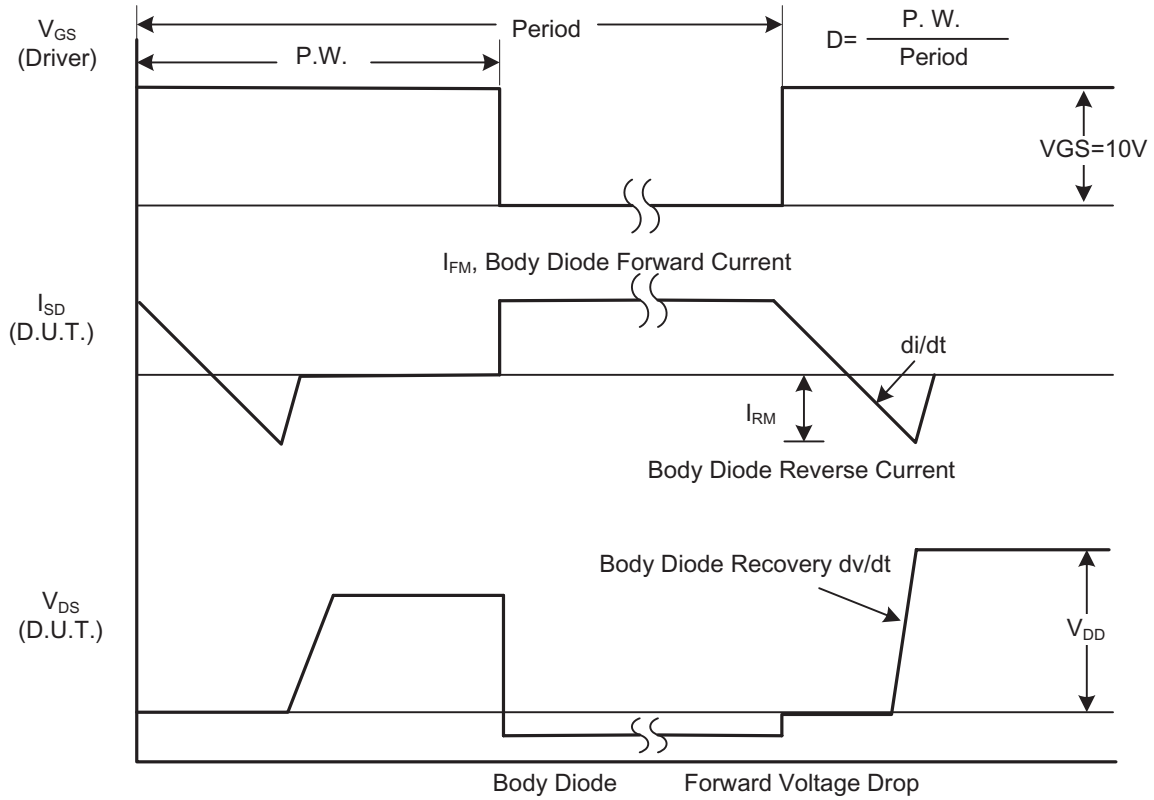
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS}=0V,I_D=250μA	650			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=650V,V_{GS}=0V			10	μA
Gate- Source Leakage Current	Forward	I_{GSS}	V_G=30V,V_{DS}=0V			100	nA
	Reverse		V_{GS}=-30V,V_{DS}=0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS},I_D=250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10V,I_D=1.0A		4	4.4	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C_{ISS}	V_{DS}=25V,V_{GS}=0V,f=1MHz		300		pF
Output Capacitance		C_{OSS}			45		pF
Reverse Transfer Capacitance		C_{RSS}			2		pF
SWITCHING CHARACTERISTICS							
Turn-On Delay Time		$t_{D(ON)}$	V_{DD}=300V,I_D=2A, R_G=25Ω(Note1, 2)		10		ns
Turn-On Rise Time		t_R			25		ns
Turn-Off Delay Time		$t_{D(OFF)}$			20		ns
Turn-Off Fall Time		t_F			25		ns
Total Gate Charge		Q_G	V_{DS}=480V,I_D=2.4A, V_{GS}=10V(Note1, 2)		5.7		nC
Gate-Source Charge		Q_{GS}			1.8		nC
Gate-Drain Charge		Q_{GD}			2		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS							
Drain-Source Diode Forward Voltage		V_{SD}	V_{GS}=0V, I_S=2. 0A			1.4	V
Maximum Continuous Drain-Source Diode Forward Current		I_S				2.0	A
Maximum Pulsed Drain-Source Diode Forward Current		I_{SM}				8.0	A
Reverse Recovery Time		t_{rr}	V_{GS}=0V, I_S=2A dI$_F$/dt=100A/μs (Note 1)		357		ns
Reverse Recovery Charge		Q_{RR}			2		μC

Notes: 1. Pulse Test: Pulse width ≤300μS, Duty cycle≤2%.
2. Essentially independent of operating temperature.

TEST CIRCUITS AND WAVEFORMS

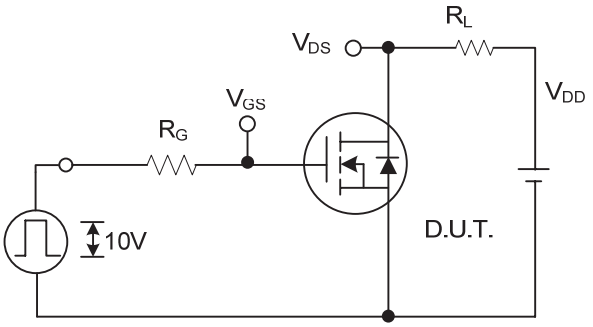


Peak Diode Recovery dv/dt Test Circuit

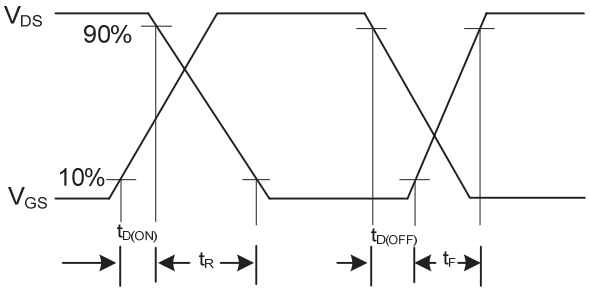


Peak Diode Recovery dv/dt Waveforms

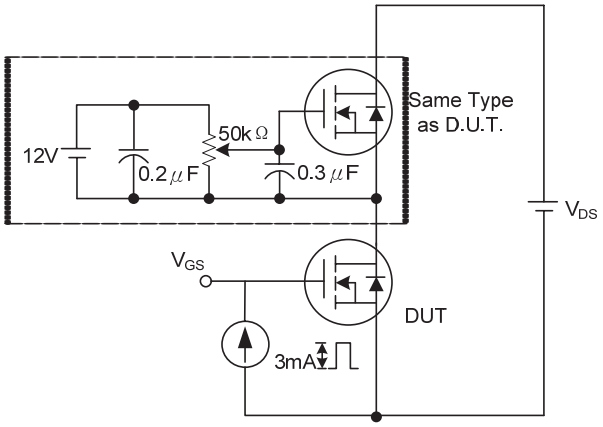
TEST CIRCUITS AND WAVEFORMS(Cont.)



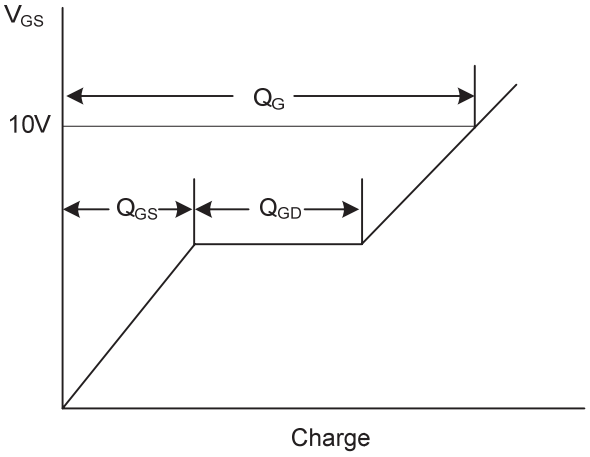
Switching Test Circuit



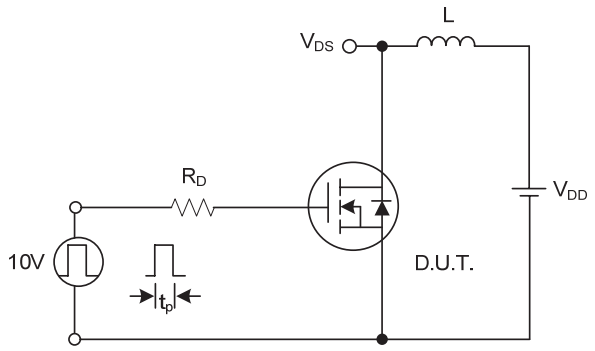
Switching Waveforms



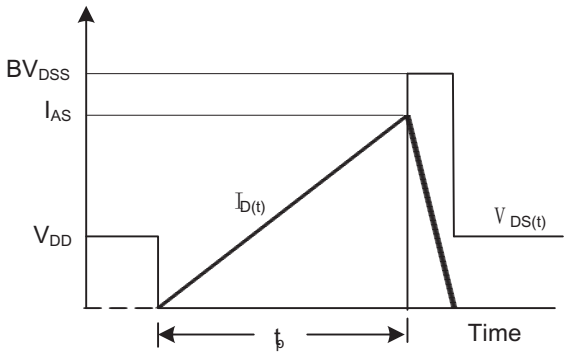
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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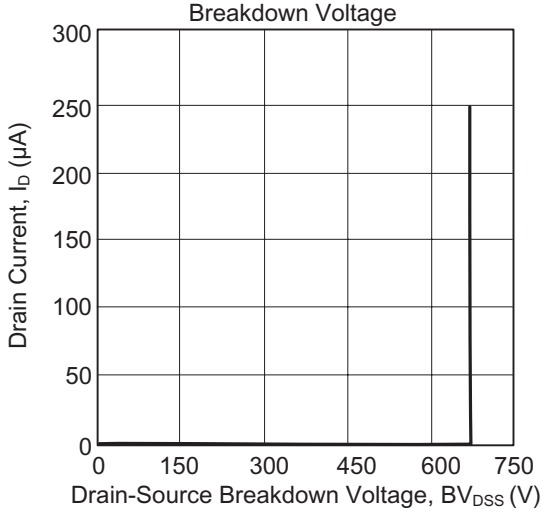
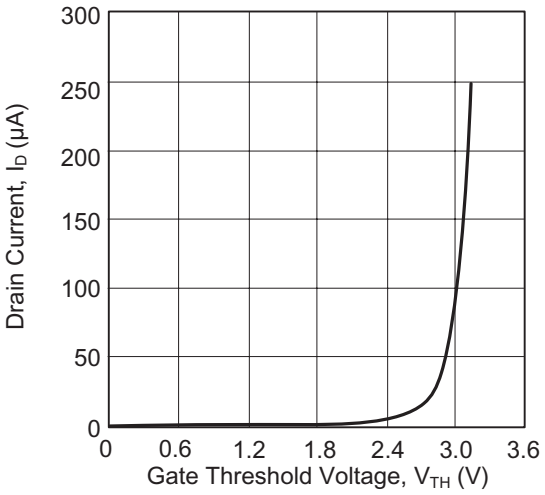
TYPICAL CHARACTERISTICS

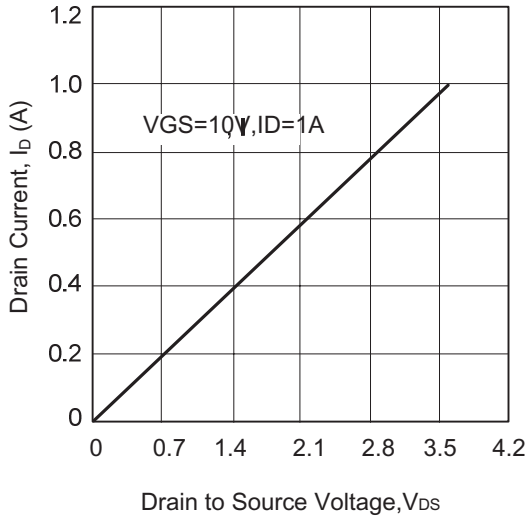
Drain Current vs. Drain-Source Breakdown Voltage



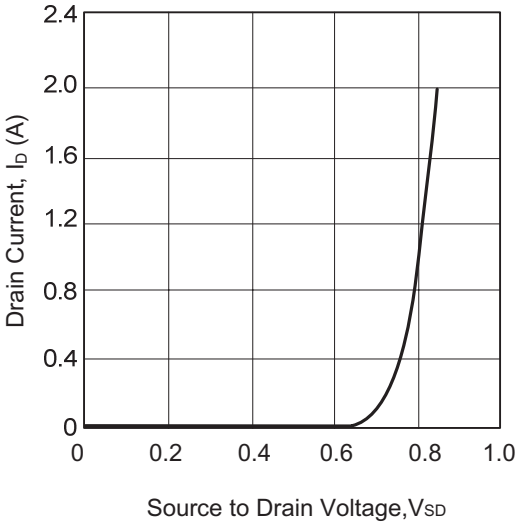
Drain Current vs. Gate Threshold Voltage



Drain-Source On-State Resistance Characteristics



Drain current vs. Source to Drain Voltage



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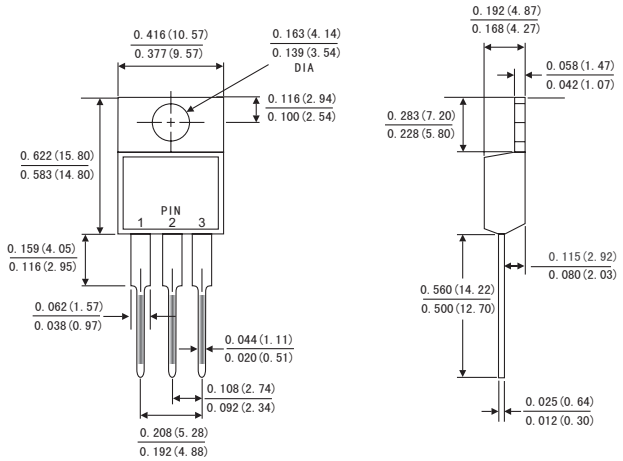
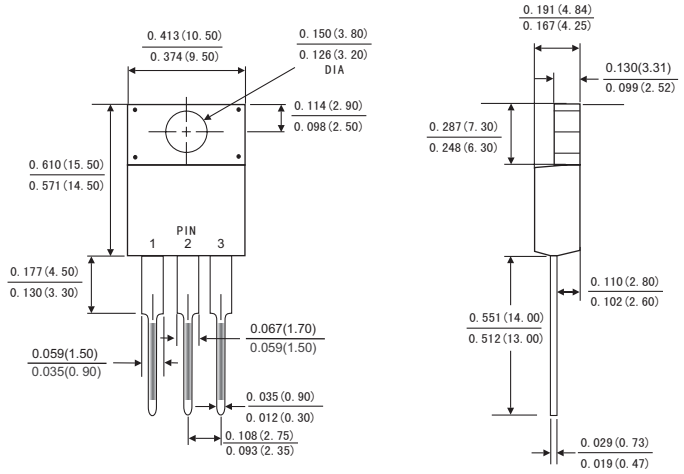
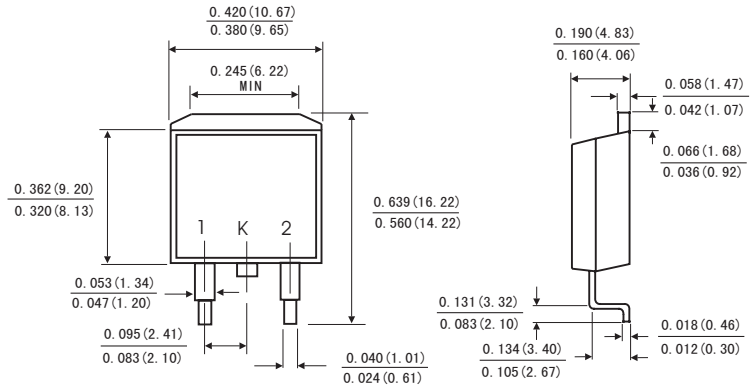
TO-220AB



ITO-220AB



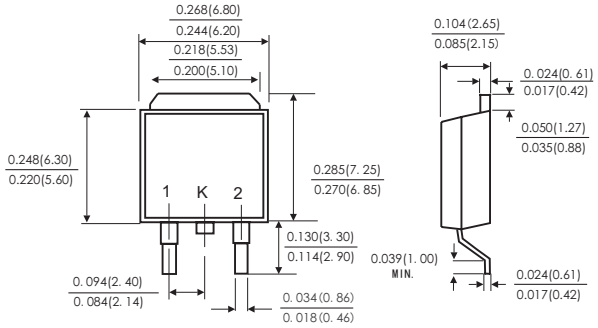
TO-263



Dimensions in inches and (millimeters)

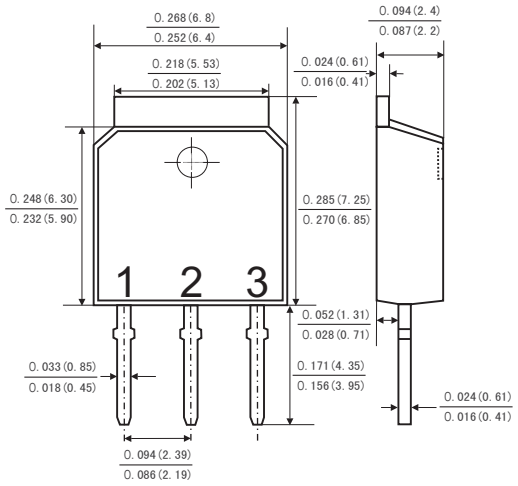
TO-252

(DPAK)



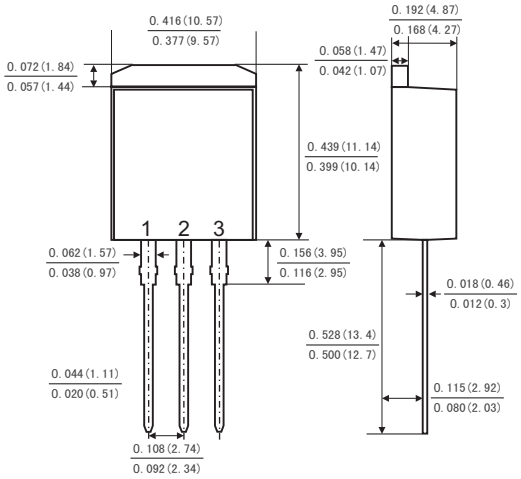
Dimensions in inches and (milimeters)

TO-251



Dimensions in inches and (milimeters)

TO-262



Dimensions in inches and (milimeters)